DATA SHEET

FBL2033
3.3V BTL 8-bit latched/registered/pass-thru universal transceiver

Product specification

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IC23 data handbook

Philips Semiconductors

PHILIPS

3.3V BTL 8-bit latched/registered/pass-thru universal transceiver

FBL2033

FEATURES

- 8-bit transceivers
- Latched, registered or straight through in either A to B or B to A path
- Drives heavily loaded backplanes with equivalent load impedances down to 10Ω.
- High drive 100mA BTL Open Collector drivers on B-port
- Allows incident wave switching in heavily loaded backplane buses
- Reduced BTL voltage swing produces less noise and reduces power consumption
- Built-in precision band-gap reference provides accurate receiver thresholds and improved noise immunity
- Compatible with IEEE Futurebus+ or proprietary BTL backplanes
- Each BTL driver has a dedicated Bus GND for a signal return
- Controlled output ramp and multiple GND pins minimize ground bounce
- Glitch-free power up/power down operation
- Low I_{CC} current
- Tight output skew
- Supports live insertion
- Pins for the optional JTAG boundary scan function are provided
- High density packaging in plastic Quad Flatpack
- 5V compatible I/O on A-port

QUICK REFERENCE DATA

SYMBOL	PARAMETER		TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay AIn to $\overline{Bn}$		3.0 3.0	ns
t_{PLH} t_{PHL}	Propagation delay $\overline{Bn}$ to AOn		5.0 5.3	ns
C_{OB}	Output capacitance ($\overline{B0} - \overline{Bn}$ only)		6	pF
I_{OL}	Output current ($\overline{B0} - \overline{Bn}$ only)		100	mA
I_{CC}	Supply current	AIn to $\overline{Bn}$ outputs Low outputs High	9 14	mA
		$\overline{Bn}$ to AOn (outputs Low)	17	
		$\overline{Bn}$ to AOn (outputs High)	14	

ORDERING INFORMATION

PACKAGE	COMMERCIAL RANGE V_{CC} = 3.3V±10%; T_{amb} = −40°C to +85°C	DWG No.
52-pin Plastic Quad Flat Pack (PQFP)	FBL2033BB	SOT379-1

NOTE: Thermal mounting or forced air is recommended

PIN CONFIGURATION

SG00088
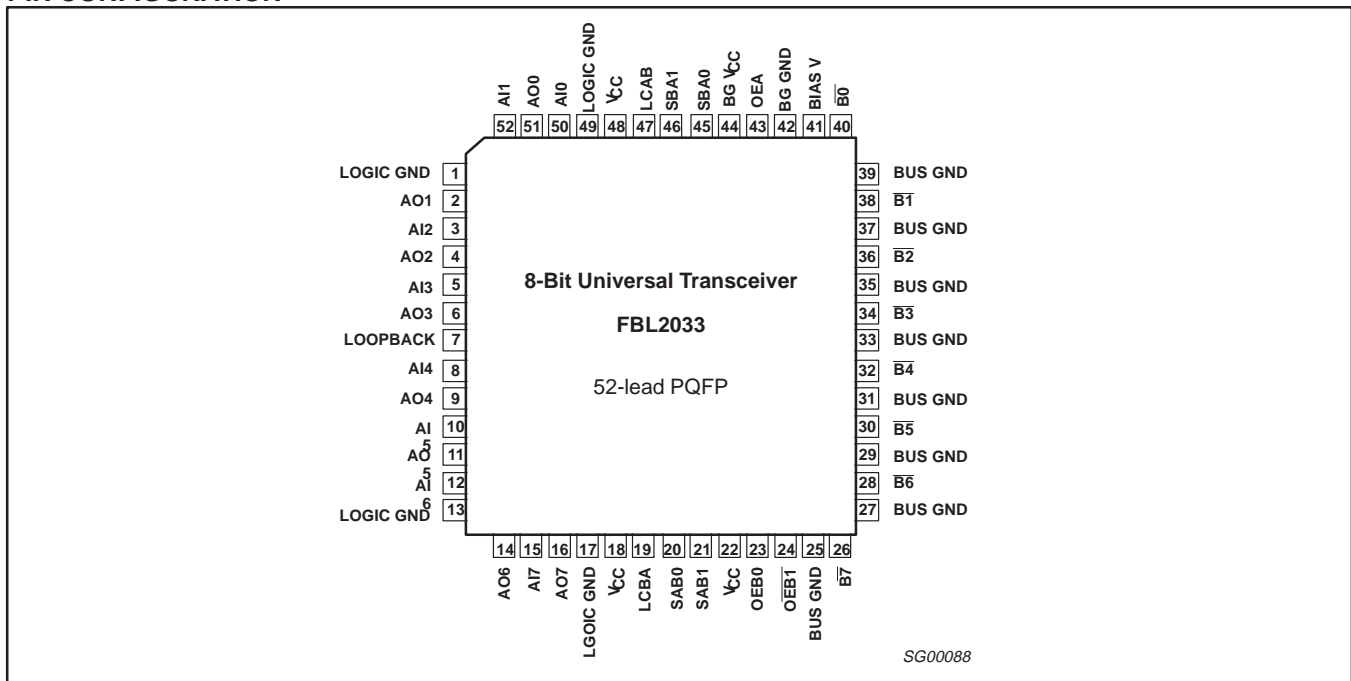
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DESCRIPTION

The FBL2033 is an 8-bit transceiver featuring a split input (AI) and output (AO) bus on the TTL-level side.

The common I/O, open collector B port operates at BTL signal levels. The logic element for data flow in each direction is controlled by two pairs of mode select inputs (SBA0 and SBA1 for B-to-A, SAB0 and SAB1 for A-to-B). It can be configured as a buffer, a register, or a D-type latch.

When configured in the buffer mode, the inverse of the input data appears at the output port. In the flip-flop mode, data is stored on the rising edge of the appropriate clock input (LCAB or LCBA). In the latch mode, clock pins serve as transparent-High latch enables. Regardless of the mode, data is inverted from input to output.

Data flow in the B-to-A direction, regardless of the logic element selected, is further controlled by the Loopback input. When the Loopback input is High the output of the selected A-to-B logic element (not inverted) becomes the B-to-A input.

The 3-State AO port is enabled by asserting a High level on OEA. The B port has two output enables, OEB0 and $\overline{OEB1}$. Only when OEB0 is High and $\overline{OEB1}$ is Low is the output enabled. When either OEB0 is Low or $\overline{OEB1}$ is High, the B-port is inactive and is pulled to the level of the pull-up voltage. New data can be entered in the flip-flop and latched modes or can be retained while the associated outputs are in 3-State (AO port) or inactive (B port).

The B-port drivers are Low-capacitance open collectors with controlled ramp and are designed to sink 100mA. Precision band gap references on the B-port ensure very good noise margins by limiting the switching threshold to a narrow region centered at 1.55V.

The B-port interfaces to "Backplane Transceiver Logic" (see the IEEE 1194.1 BTL standard). BTL features low power consumption by reducing voltage swing (1V p-p, between 1V and 2V) and reduced capacitive loading by placing an internal series diode on the drivers. BTL also provides incident wave switching, a necessity for high performance backplanes.

Output clamps are provided on the BTL outputs to further reduce switching noise. The "V_{OH}" clamp reduces inductive ringing effects during a Low-to-High transition. The "V_{OH}" clamp is always active. The other clamp, the "trapped reflection" clamp, clamps out ringing below the BTL 0.5V V_{OL} level. This clamp remains active for approximately 100ns after a High-to-Low transition.

To support live insertion, OEB0 is held Low during power on/off cycles to ensure glitch- free B port drivers. Proper bias for B port drivers during live insertion is provided by the BIAS V pin when at a 3.3V level while V_{CC} is Low. The BIAS V pin is a low current input which will reverse-bias the BTL driver series Schottky diode, and also bias the B port output pins to a voltage between 1.62V and 2.1V. This bias function is in accordance with IEEE BTL Standard 1194.1. If live insertion is not a requirement, the BIAS V pin should be tied to a V_{CC} pin.

The LOGIC GND and BUS GND pins are isolated inside the package to minimize noise coupling between the BTL and TTL sides. These pins should be tied to a common ground external to the package.

Each BTL driver has an associated BUS GND pin that acts as a signal return path and these BUS GND pins are internally isolated from each other. In the event of a ground return fault, a "hard" signal failure occurs instead of a pattern dependent error that may be very infrequent and impossible to trouble- shoot.

As with any high power device thermal considerations are critical. It is recommended that airflow (300lfpm) and/or thermal mounting be used to ensure proper junction temperature.

PIN DESCRIPTION

SYMBOL	PIN NUMBER	TYPE	NAME AND FUNCTION
AI0 – AI7	50, 52, 3, 5, 8, 10, 12, 15	Input	Data inputs (TTL)
AO0 – AO7	51, 2, 4, 6, 9, 11, 14, 16	Output	3-State outputs (TTL)
$\overline{B0}$ – $\overline{B7}$	40, 38, 36, 34, 32, 30, 28, 26	I/O	Data inputs/Open Collector outputs, High current drive (BTL)
OEB0	23	Input	Enables the B outputs when High
$\overline{OEB1}$	24	Input	Enables the B outputs when Low
OEA	43	Input	Enables the AO outputs when High
BUS GND	39, 37, 35, 33, 31, 29, 27, 25	GND	Bus ground (0V)
LOGIC GND	1, 13, 17, 49	GND	Logic ground (0V)
V_{CC}	18, 22, 48	Power	Positive supply voltage
BIAS V	41	Power	Live insertion pre-bias pin
BG V_{CC}	44	Power	Band Gap threshold voltage reference
BG GND	42	GND	Band Gap threshold voltage reference ground
SABn	20, 21	Input	Mode select from AI to $\overline{B}$
SBAn	45, 46	Input	Mode select from $\overline{B}$ to AO
LCAB	47	Input	A-to-B clock/latch enable (transparent latch when High)
LCBA	19	Input	B-to-A clock/latch enable (transparent latch when High)
Loopback	7	Input	Enables loopback function when High (from AIn to AOn)

FUNCTION TABLE

MODE	INPUTS									OUTPUTS	
	AIn	$\overline{Bn}$*	OEB0	$\overline{OEB1}$	OEA	LCAB	LCBA	SAB_{10}	SBA_{10}	AOn	$\overline{Bn}$
AIn to $\overline{Bn}$ thru mode	L	—	H	L	L	X	X	LL	XX	Z	H**
	H	—	H	L	L	X	X	LL	XX	Z	L
AIn to $\overline{Bn}$ transparent latch	L	—	H	L	L	H	X	HX	XX	Z	H**
	H	—	H	L	L	H	X	HX	XX	Z	L
AIn to $\overline{Bn}$ latch and read	l	—	H	L	L	↓	X	HX	XX	Z	H**
	h	—	H	L	L	↓	X	HX	XX	Z	L
AIn to $\overline{Bn}$ register	L	—	H	L	L	↑	X	LH	XX	Z	H**
	H	—	H	L	L	↑	X	LH	XX	Z	L
$\overline{Bn}$ outputs latched and read (preconditioned latch)	X	—	H	L	L	L	X	HX	XX	Z	latched data
$\overline{Bn}$ to AOn thru mode	X	L	L	H	H	X	X	XX	LL	H	input
	X	H	L	H	H	X	X	XX	LL	L	input
$\overline{Bn}$ to AOn transparent latch	X	L	L	H	H	X	H	XX	HX	H	input
	X	H	L	H	H	X	H	XX	HX	L	input
$\overline{Bn}$ to AOn latch and read	X	l	L	H	H	X	↓	XX	HX	H	input
	X	h	L	H	H	X	↓	XX	HX	L	input
$\overline{Bn}$ to AOn register	X	L	L	H	H	X	↑	XX	LH	H	input
	X	H	L	H	H	X	↑	XX	LH	L	input
AOn outputs latched and read (preconditioned latch)	X	X	L	H	H	X	L	XX	HX	latched data	X
Disable $\overline{Bn}$ outputs	X	X	L	X	X	X	X	XX	XX	X	H**
	X	X	X	H	X	X	X	XX	XX	X	H**
Disable AOn outputs	X	X	X	X	L	X	X	XX	XX	Z	X

FUNCTION SELECT TABLE

MODE SELECTED	SXX1	SXX0
Thru mode	L	L
Register mode	L	H
Latch mode	H	X

NOTES:
H = High voltage level
L = Low voltage level
h = High voltage level one set-up time prior to the High-to-Low LCXX transition
l = Low voltage level one set-up time prior to the High-to-Low LCXX transition
X = Don't care
Z = High-impedance (OFF) state
— = Input not externally driven
↑ = Low-to-High transition
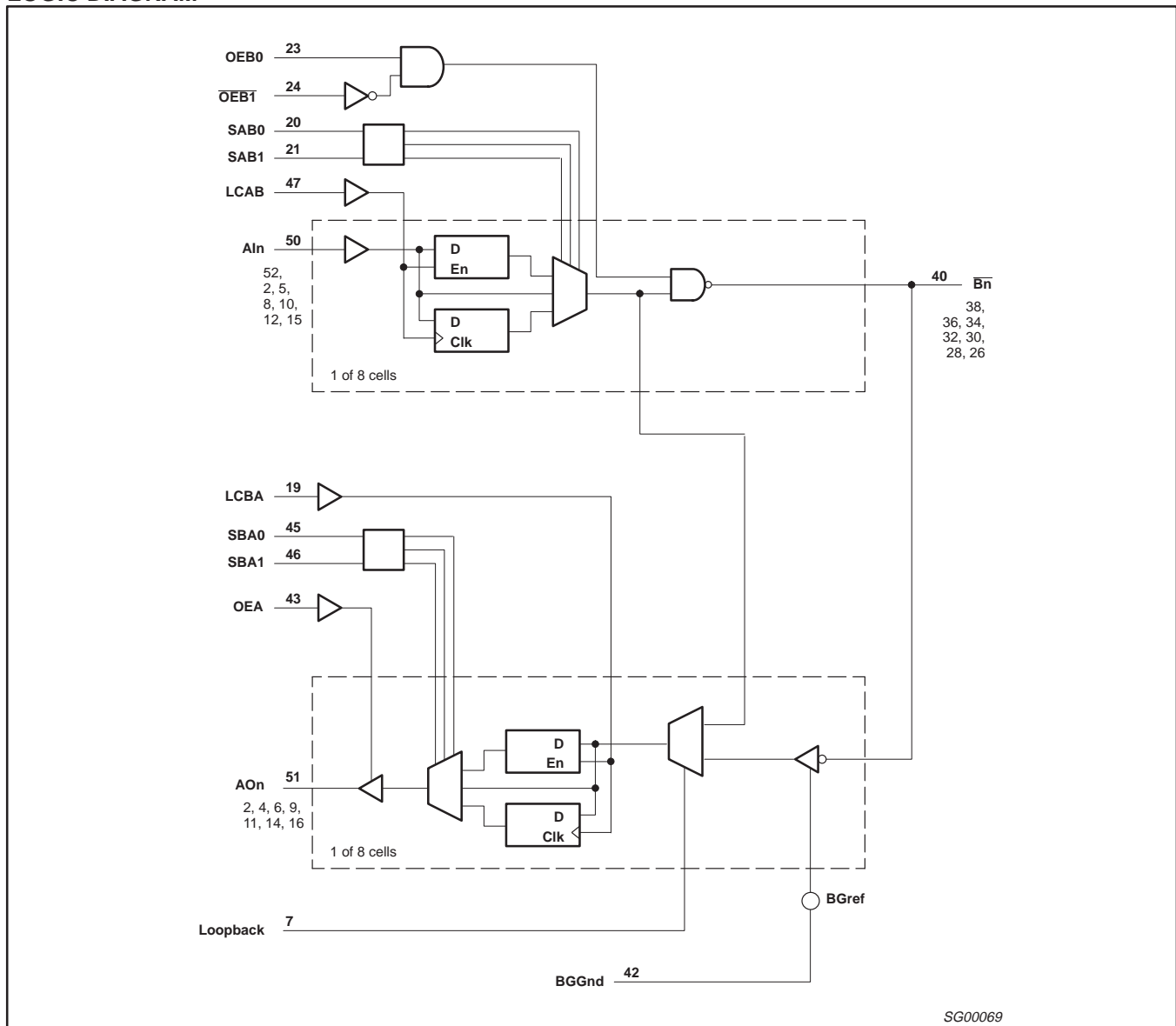↓ = High-to-Low transition
H** = Goes to level of pull-up voltage
$\overline{Bn}$* = Precaution should be taken to ensure B inputs do not float. If they do, they are equal to Low state.
In Loopback mode (Loopback = High), AIn inputs are routed to the AOn outputs. The $\overline{Bn}$ inputs are blocked out.

LOGIC DIAGRAM

SG00069

ABSOLUTE MAXIMUM RATINGS

Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		-0.5 to +4.6	V
V_{IN}	Input voltage	AI0 – AI7, OEB0, $\overline{OEBn}$, OEAn	-0.5 to +7.0	V
		$\overline{B0} - \overline{B7}$	-0.5 to +3.5	
I_{IN}	Input current	$V_{IN} < 0$	-50	
V_{OUT}	Voltage applied to output in High output state		-0.5 to +7.0	V
I_{OUT}	Current applied to output in	AO0 – AO7	64, –64	mA
	Low output state/High output state	$\overline{B0} - \overline{B7}$	200	
T_{STG}	Storage temperature		-65 to +150	°C

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		COMMERCIAL LIMITS $V_{CC} = 3.3V\pm10\%$; $T_{amb} = -40$ to $+85°C$			UNIT
			MIN	TYP	MAX	
V_{CC}	Supply voltage		3.0	3.3	3.6	V
V_{IH}	High-level input voltage	Except $\overline{B0}$–$\overline{B7}$	2.0			V
		$\overline{B0}$ – $\overline{B7}$	1.62	1.55		
V_{IL}	Low-level input voltage	Except $\overline{B0}$–$\overline{B7}$			0.8	V
		$\overline{B0}$ – $\overline{B7}$			1.47	
I_{IK}	Input clamp current				-18	mA
I_{OH}	High-level output current	AO0 – AO7			-12	mA
I_{OL}	Low-level output current	AO0 – AO7			+12	mA
		$\overline{B0}$ – $\overline{B7}$			100	
C_{OB}	Output capacitance on B port			6	7	pF
T_{amb}	Operating free-air temperature range		0		+70	°C

LIVE INSERTION SPECIFICATIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	TYP	MAX	
V_{BIASV}	Bias pin voltage	Voltage difference between the Bias voltage and V_{CC} after the PCB is plugged in.	–	–	0.5	V
I_{BIASV}	Bias pin (I_{BIASV}) input DC current	$V_{CC} = 0$ V, Bias V = 3.6V			1.2	mA
		$V_{CC} = 3.3$V, Bias V = 3.6V			10	μA
$V_{\overline{Bn}}$	Bus voltage during prebias	$\overline{B0}$ – $\overline{B7}$ = 0V, Bias V = 3.3V	1.62		2.1	V
I_{LM}	Fall current during prebias	$\overline{B0}$ – $\overline{B7}$ = 2V, Bias V = 1.3 to 2.5V			1	μA
I_{HM}	Rise current during prebias	$\overline{B0}$ – $\overline{B7}$ = 1V, Bias V = 3 to 3.6V	-1			μA
$I_{\overline{Bn}}PEAK$	Peak bus current during insertion	$V_{CC} = 0$ to 3.3V, $\overline{B0}$ – $\overline{B7}$ = 0 to 2.0V, Bias V = 2.7 to 3.6V, OEB0 = 0.8V, t_r = 2ns			10	mA
$I_{OL}OFF$	Power up current	$V_{CC} = 0$ to 3.3V, OEB0 = 0.8V			100	μA
		$V_{CC} = 0$ to 1.2V, OEB0 = 0 to 5V			100	
t_{GR}	Input glitch rejection	$V_{CC} = 3.3$V	1.0	1.35		ns

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range unless otherwise noted.

symbol	parameter		test conditions[1]	min	typ[2]	max	unit
				limits			
I_{OH}	High level output current	$\overline{B0} - \overline{B7}$	V_{CC} = MAX, V_{IL} = MAX, V_{OH} = 1.9V			100	µA
I_{OFF}	Power-off output current	$\overline{B0} - \overline{B7}$	V_{CC} = 0V, V_{IL} = MAX, V_{OH} = 1.9V			100	µA
			V_{CC} = 0V, V_{IL} = MAX, V_{OH} = 1.9V@85°C			300	
V_{OH}	High-level output voltage	AO0 – AO7[3]	V_{CC} = MIN to MAX; I_{OH} = -100µA	V_{CC} −0.2			V
			V_{CC} = MIN; I_{OH} = -8mA	2.4			V
			V_{CC} = MIN; I_{OH} = -32mA	2.0			V
V_{OL}	Low-level output voltage	AO0 – AO7[3]	V_{CC} = MIN; I_{OL} = 16mA			0.4	V
			V_{CC} = MIN; I_{OL} = 32mA			0.5	V
		$\overline{B0} - \overline{B7}$	V_{CC} = MIN, I_{OL} = 4mA	0.5			V
			V_{CC} = MIN, I_{OL} = 100mA	0.75	1.0	1.20	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, $I_I = I_{IK} = −18mA$		−0.85	-1.2	V
I_I	Input leakage current	Control pins	V_{CC} = 3.6V; $V_I = V_{CC}$ or 300mV			±1.0	µA
		Control/ AI0 – AI7	V_{CC} = 0V or 3.6V; V_I = 5.5V			10	
		AI0 – AI7	V_{CC} = 3.6V; $V_I = V_{CC}$			1	
		Note 4	V_{CC} = 3.6V; V_I = 300mV			−5	
I_{IH}	High-level input current	$\overline{B0} - \overline{B7}$	V_{CC} = MAX, V_I = 1.9V			100	µA
			V_{CC} = MAX, V_I = 3.5V, note 5	100			mA
			V_{CC} = MAX, V_I = 3.75V, Note 5 @ −40°C	100			
I_{IL}	Low-level input current	$\overline{B0} - \overline{B7}$	V_{CC} = MAX, V_I = 0.75V			-100	µA
I_{OZH}	Off-state output current	AO0 – AO7	V_{CC} = MAX, V_O =3V			5	µA
I_{OZL}	Off-state output current	AO0 – AO7	V_{CC} = MAX, V_O = 0.5V			-5	µA
I_{CCH} I_{CCL}	Supply current (total)	B→A	V_{CC} = MAX, outputs High		14	31	mA
			V_{CC} = MAX, outputs Low		17	38	
I_{CCZ}	Supply current		V_{CC} = MAX		22	55	mA
I_{CCH} I_{CCL}	Supply current (total)	A→B	V_{CC} = MAX, outputs High		14	32	mA
			V_{CC} = MAX, outputs Low		9	18	
I_{CCZ}	Supply current		V_{CC} = MAX		14	33	mA

NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
2. All typical values are at V_{CC} = 3.3V, T_A = 25°C.
3. Due to test equipment limitations, actual test conditions are V_{IH} = 1.8V and V_{IL} = 1.3V for the B side.
4. Unused pins are at V_{CC} or GND.
5. For B port input voltage between 3 and 5 volt; I_{IH} will be greater than 100mA but the part will continue to function normally (clamping circuit is active).

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AC ELECTRICAL CHARACTERISTICS INDUSTRIAL AND COMMERCIAL (A TO B)

SYMBOL	PARAMETER	TEST CONDITION	MIN	TYP	MAX	MIN	MAX	UNIT
t_{PLH} t_{PHL}	Propagation delay, An to $\overline{B}n$ through latch		1.2 1.2	2.7 2.6	4.8 4.3	1.0 1.0	5.3 4.9	ns
t_{PLH} t_{PHL}	Propagation delay, An to $\overline{B}n$ transparent latch		1.3 1.8	3.2 3.7	5.2 5.6	1.0 1.6	6.1 6.3	ns
t_{PLH} t_{PHL}	Propagation delay, LCAB to $\overline{B}n$ latch		2.0 2.3	3.8 4.3	5.8 6.3	1.2 1.8	7.0 7.3	ns
t_{PLH} t_{PHL}	Propagation delay, LCAB to $\overline{B}n$ register		2.1 2.0	3.8 4.3	5.7 6.5	1.4 1.8	6.9 7.3	ns
t_{PLH} t_{PHL}	Propagation delay, SABX to $\overline{B}n$ inverting		1.2 2.3	4.3 5.1	7.6 8.0	1.0 2.0	9.2 8.7	ns
t_{PLH} t_{PHL}	Propagation delay, SABX to $\overline{B}n$ non-inverting		1.8 1.8	4.0 5.0	6.4 8.5	1.1 1.6	8.0 9.8	ns
t_{PLH} t_{PHL}	OEBn to $\overline{B}n$		1.5 1.6	3.4 3.4	5.4 5.3	1.0 1.0	6.0 7.2	ns

AC ELECTRICAL CHARACTERISTICS INDUSTRIAL AND COMMERCIAL (A TO B)

SYMBOL	PARAMETER	TEST CONDITION	$T_{amb} = +25°C$, $V_{CC} = 3.3V$, $R_L = 16.5\Omega$			$T_{amb} = -40$ to $+85°C$, $V_{CC} = 3.3V\pm10\%$, $R_L = 16.5\Omega$		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, An to $\overline{B}n$ through latch		1.2 1.2	2.8 2.4	4.5 4.0	1.0 1.0	5.7 4.6	ns
t_{PLH} t_{PHL}	Propagation delay, An to $\overline{B}n$ transparent latch		1.4 1.7	3.2 3.5	5.1 5.4	1.0 1.3	6.1 5.9	ns
t_{PLH} t_{PHL}	Propagation delay, LCAB to $\overline{B}n$ latch		2.0 2.2	3.8 4.1	5.6 6.1	1.3 1.6	6.9 7.0	ns
t_{PLH} t_{PHL}	Propagation delay, LCAB to $\overline{B}n$ register		2.0 2.2	3.9 4.1	5.9 6.1	1.2 1.6	7.7 7.0	ns
t_{PLH} t_{PHL}	Propagation delay, SABX to $\overline{B}n$ inverting		1.2 1.8	4.6 4.7	8.6 7.9	1.0 1.6	10.4 8.7	ns
t_{PLH} t_{PHL}	Propagation delay, SABX to $\overline{B}n$ non-inverting		1.3 1.5	4.5 4.6	8.2 8.2	1.0 1.2	10.0 9.1	ns
t_{PLH} t_{PHL}	OEBn to $\overline{B}n$		1.5 1.5	3.4 3.2	6.0 7.2	1.0 1.0	6.3 7.0	ns

AC ELECTRICAL CHARACTERISTICS INDUSTRIAL AND COMMERCIAL (B TO A)

SYMBOL	PARAMETER	TEST CONDITION	T_{amb} = +25°C, V_{CC} = 3.3V			T_{amb} = −40 to +85°C, V_{CC} = 3.3V±10%		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, $\overline{B}$n to An through mode		2.5 3.0	4.5 5.1	6.5 7.3	1.6 2.6	7.8 9.1	ns
t_{PLH} t_{PHL}	Propagation delay, $\overline{B}$n to An transparent latch		3.4 3.2	5.4 5.4	7.6 7.6	2.2 2.7	9.2 9.3	ns
t_{PLH} t_{PHL}	Propagation delay, LCAB to An latch		2.1 1.6	3.9 3.3	5.8 5.0	1.3 1.2	7.2 5.9	ns
t_{PLH} t_{PHL}	Propagation delay, LCAB to An register		1.9 2.3	3.7 4.1	5.7 6.0	1.1 1.8	6.8 7.0	ns
t_{PLH} t_{PHL}	Propagation delay, SABX to An inverting		2.3 2.5	4.2 4.5	6.4 6.5	1.3 2.0	7.9 7.4	ns
t_{PLH} t_{PHL}	Propagation delay, SABX to An non-inverting		1.4 1.9	3.9 4.0	8.7 6.1	1.0 1.5	9.8 7.1	ns
t_{PLH} t_{PHL}	Propagation delay, AIn to AOn loopback		2.4 2.3	4.3 4.4	6.3 6.6	1.6 1.6	8.1 7.6	ns
t_{PLH} t_{PHL}	Propagation delay, LPBK to An non-inverting or inverting		2.0 1.3	4.3 4.9	7.0 9.4	1.4 1.5	8.9 11.3	ns
t_{PZH} t_{PHZ}	Propagation delay, OEA to An		2.4 3.1	4.3 5.3	6.3 7.6	1.9 2.5	7.3 8.9	ns
t_{PZH} t_{PHZ}	Propagation delay, OEA to An		2.1 1.4	4.0 2.7	6.2 4.4	1.7 1.0	6.9 5.2	ns

AC SETUP REQUIREMENTS INDUSTRIAL AND COMMERCIAL

SYMBOL	PARAMETER	TEST CONDITION	LIMITS		UNIT
			T_{amb} = +25°C, V_{CC} = 3.3V	T_{amb} = −40 to +85°C, V_{CC} = 3.3V±10%	
			C_L = 50pF (A side) / C_D = 30pF (B side) R_L = 500Ω (A side) / R_U = 9Ω (B side)		
			MIN	MIN	
t_s(H) t_s(L)	Setup time AIn to LCAB or $\overline{Bn}$ to LCBA		3.0 3.0	4.0 4.0	ns
t_h(H) t_h(L)	Hold time (latch mode) AIn to LCAB		6.0 5.0	6.5 5.5	ns
t_h(H) t_h(L)	Hold time (register mode) AIn to LCAB		1.0 1.0	1.3 1.3	ns
t_h(H) t_h(L)	Hold time (latch mode) $\overline{Bn}$ to LCAB		1.5 1.5	2.0 2.0	ns
t_h(H) t_h(L)	Hold time (register mode) $\overline{Bn}$ to LCAB		1.0 1.0	1.3 1.3	ns
t_w(H) t_w(L)	Pulse width, High or Low AIn to LCAB or $\overline{Bn}$ to LCBA		3.0 3.0	4.0 4.0	ns

AC SETUP REQUIREMENTS INDUSTRIAL AND COMMERCIAL

SYMBOL	PARAMETER	TEST CONDITION	LIMITS		UNIT
			T_{amb} = +25°C, V_{CC} = 3.3V	T_{amb} = −40 to +85°C, V_{CC} = 3.3V±10%	
			C_L = 50pF (A side) / C_D = 30pF (B side) R_L = 500Ω (A side) / R_U = 16.5Ω (B side)		
			MIN	MIN	
t_s(H) t_s(L)	Setup time AIn to LCAB or $\overline{Bn}$ to LCBA		3.0 3.0	4.0 4.0	ns
t_h(H) t_h(L)	Hold time (latch mode) AIn to LCAB		6.0 5.0	6.5 5.5	ns
t_h(H) t_h(L)	Hold time (register mode) AIn to LCAB		1.0 1.0	1.3 1.3	ns
t_h(H) t_h(L)	Hold time (latch mode) $\overline{Bn}$ to LCAB		1.5 1.5	2.0 2.0	ns
t_h(H) t_h(L)	Hold time (register mode) $\overline{Bn}$ to LCAB		1.0 1.0	1.3 1.3	ns
t_w(H) t_w(L)	Pulse width, High or Low AIn to LCAB or $\overline{Bn}$ to LCBA		3.0 3.0	4.0 4.0	ns

AC WAVEFORMS

**Waveform 1.   Propagation Delay for Data
or Output Enable to Output**
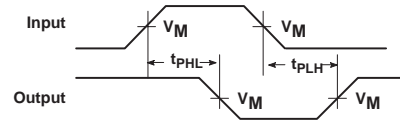
**Waveform 2.   Propagation Delay for Data
or Output Enable to Output**
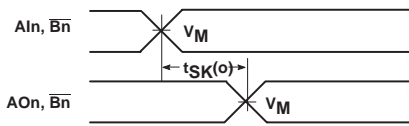
Waveform 3.   Output to Output Skew
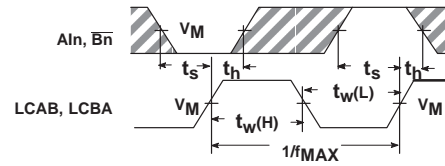
**Waveform 4.   Setup and Hold Times,
Pulse Widths and Maximum Frequency**
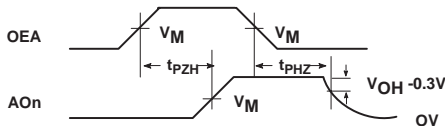
**Waveform 5.   3-State Output Enable Time to High Level
and Output Disable Time from High Level**
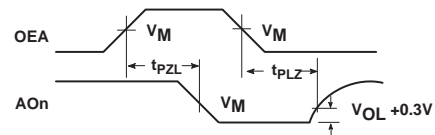
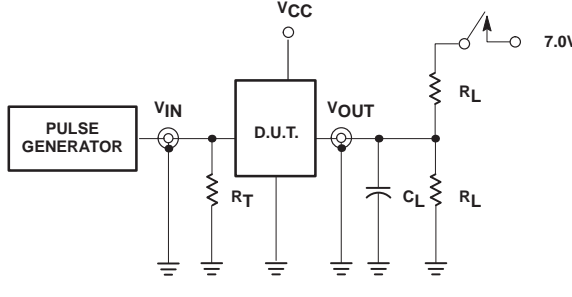**Waveform 6.   3-State Output Enable Time to Low Level
and Output Disable Time from Low Level**

NOTE: The shaded areas indicate when the input is permitted to change for predictable output performance.

SG00070
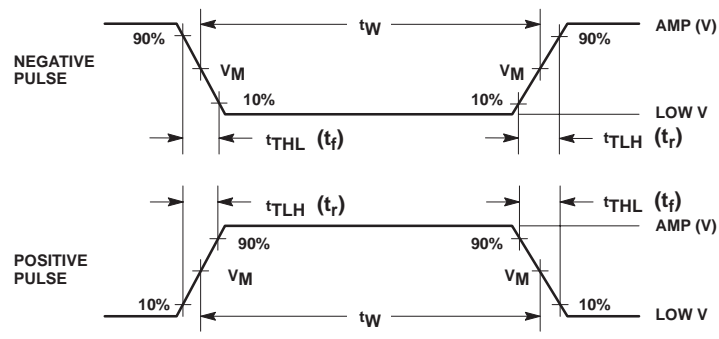
TEST CIRCUIT AND WAVEFORMS

Test Circuit for 3-State Outputs on A Port

SWITCH POSITION

TEST	SWITCH
t_{PLZ}, t_{PZL}	closed
All other	open

Test Circuit for Outputs on B Port

2.0V (for $R_U = 9\ \Omega$)
2.1V (for $R_U = 16.5\ \Omega$)

$V_M = 1.55V$ for $\overline{Bn}$, $V_M = 1.5V$ for all others.
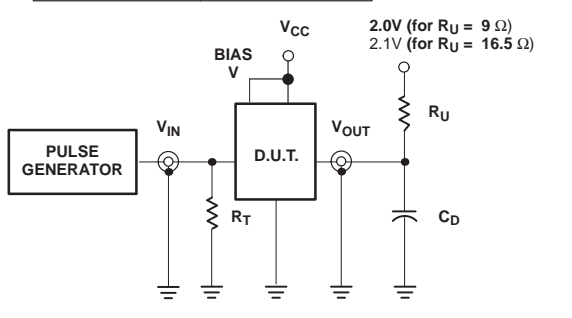
Input Pulse Definitions

Family	INPUT PULSE REQUIREMENTS					
FB+	Amplitude	Low V	Rep. Rate	t_W	t_{TLH}	t_{THL}
A Port	3.0V	0.0V	1MHz	500ns	2.5ns	2.5ns
B Port	2.0V	1.0V	1MHz	500ns	2.0ns	2.0ns

DEFINITIONS:
R_L = Load Resistor; see AC CHARACTERISTICS for value.
C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.
C_D = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
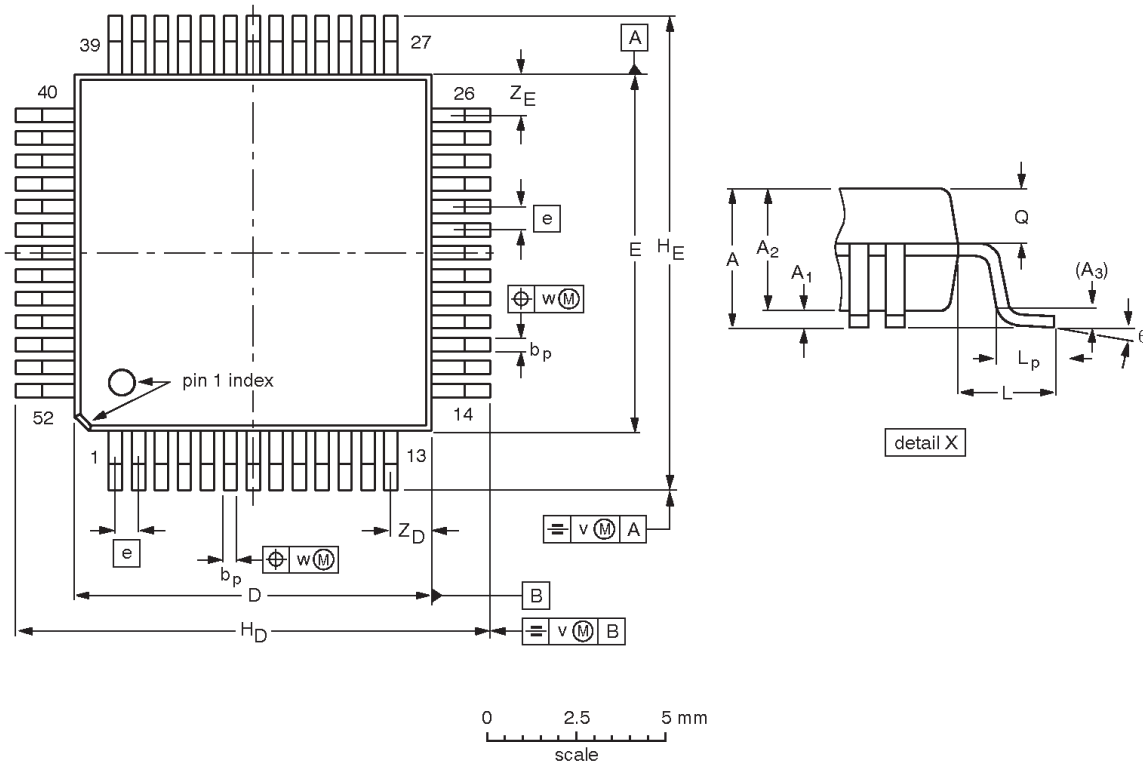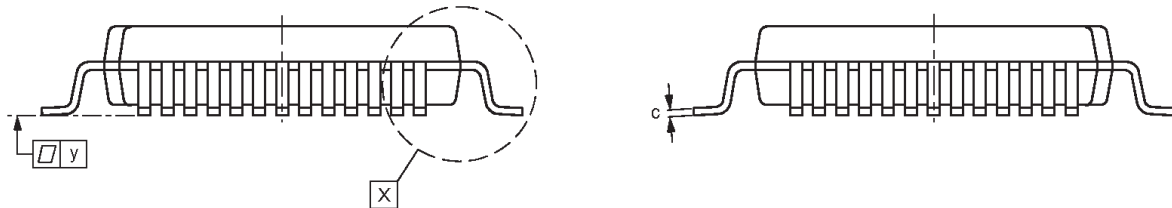R_U = Pull up resistor; see AC CHARACTERISTICS for value.

SG00063

3.3V BTL 8-bit latched/registered/pass-thru Futurebus+ universal interface transceiver

FBL2033

QFP52: plastic quad flat package; 52 leads (lead length 1.6 mm); body 10 x 10 x 2.0 mm   **SOT379-1**

0   2.5   5 mm

scale

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_D	H_E	L	L_p	Q	v	w	y	$Z_D^{(1)}$	$Z_E^{(1)}$	θ
mm	2.45	0.45 0.25	2.10 1.95	0.25	0.38 0.22	0.23 0.13	10.1 9.9	10.1 9.9	0.65	13.45 12.95	13.45 12.95	1.60	0.95 0.65	1.05 0.90	0.20	0.12	0.10	1.24 0.95	1.24 0.95	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT379-1		MO-108				95-02-04

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1]   Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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